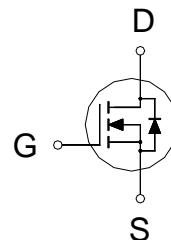


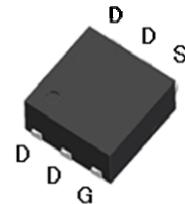
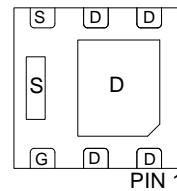
N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV _{DSS}	20V
R _{DSON} (MAX.)	20mΩ
I _D	7A



Bottom View



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNIT
Gate-Source Voltage	V _{GS}	±12	V
Continuous Drain Current	I _D	7	A
		4.5	
Pulsed Drain Current ¹	I _{DM}	28	
Power Dissipation	P _D	2.08	W
		0.83	
Operating Junction & Storage Temperature Range	T _j , T _{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	R _{θJC}	12	60	°C / W
Junction-to-Ambient ³	R _{θJA}			

¹Pulse width limited by maximum junction temperature.

²Duty cycle ≤ 1%

³60°C / W when mounted on a 1 in² pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	20			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.35	0.65	1.0	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 12V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 16V, V_{GS} = 0V$			1	μA
		$V_{DS} = 16V, V_{GS} = 0V, T_J = 125^\circ\text{C}$			10	
On-State Drain Current ¹	$I_{D(\text{ON})}$	$V_{DS} = 5V, V_{GS} = 4.5V$	7			A
Drain-Source On-State Resistance ¹	$R_{DS(\text{ON})}$	$V_{GS} = 4.5V, I_D = 6A$		17	20	$\text{m}\Omega$
		$V_{GS} = 2.5V, I_D = 5A$		20	25	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 6A$		7		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 10V, f = 1\text{MHz}$		560		pF
Output Capacitance	C_{oss}			166		
Reverse Transfer Capacitance	C_{rss}			150		
Total Gate Charge ^{1,2}	Q_g	$V_{DS} = 10V, V_{GS} = 4.5V, I_D = 6A$		8.5		nC
Gate-Source Charge ^{1,2}	Q_{gs}			1.5		
Gate-Drain Charge ^{1,2}	Q_{gd}			3.5		
Turn-On Delay Time ^{1,2}	$t_{d(\text{on})}$	$V_{DS} = 10V, I_D = 1A, V_{GS} = 4.5V, R_{GS} = 6\Omega$		12		nS
Rise Time ^{1,2}	t_r			15		
Turn-Off Delay Time ^{1,2}	$t_{d(\text{off})}$			30		
Fall Time ^{1,2}	t_f			15		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_C = 25^\circ\text{C}$)						
Continuous Current	I_S				7	A
Pulsed Current ³	I_{SM}				28	
Forward Voltage ¹	V_{SD}	$I_F = I_S, V_{GS} = 0V$			1.2	V

¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

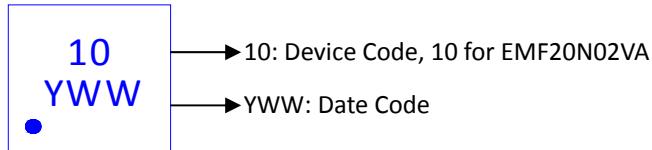
²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

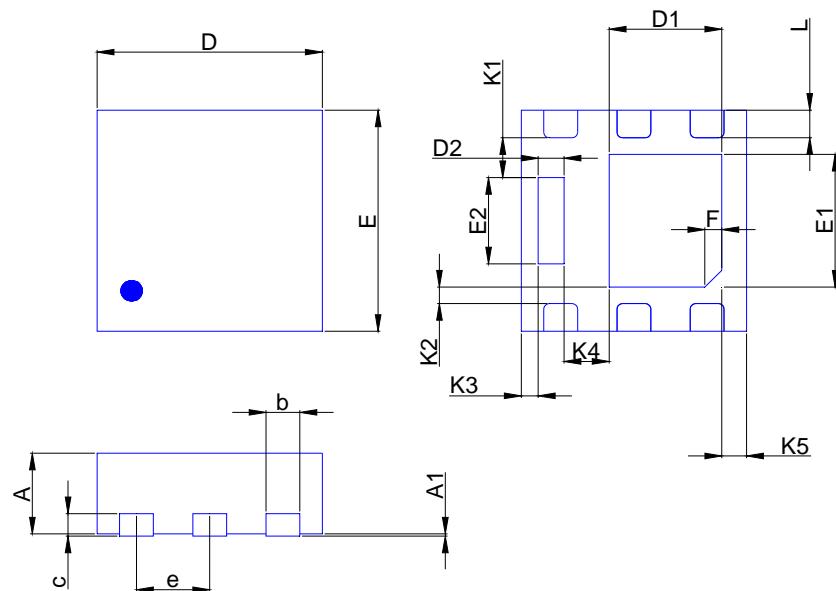


Ordering & Marking Information:

Device Name: EMF20N02VA for EDFN 2 x 2



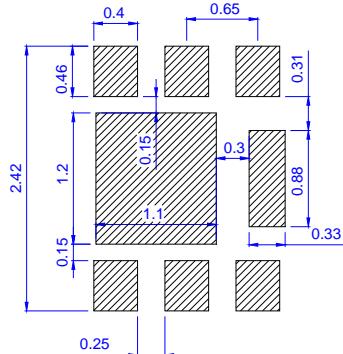
Outline Drawing



Dimension in mm

Dimension	A	A1	b	c	D	D1	D2	E	E1	E2	e	F	f	K1	K2	L	K3	K4	K5
Min.	0.70	0.00	0.25		1.9	0.9	0.13	1.9	1.1	0.68				0.306	0.10	0.2	0.10	0.35	0.17
Typ.	0.75	0.02	0.30	0.203	2.0	1.0	0.23	2.0	1.2	0.78	0.65	0.15	45°	0.356	0.15	0.25	0.15	0.40	0.22
Max.	0.80	0.05	0.35		2.1	1.1	0.33	2.1	1.3	0.88				0.406	0.20	0.3	0.20	0.45	0.27

Recommended minimum pads





TYPICAL CHARACTERISTICS

